

NCE N-Channel Enhancement Mode Power MOSFET

Description

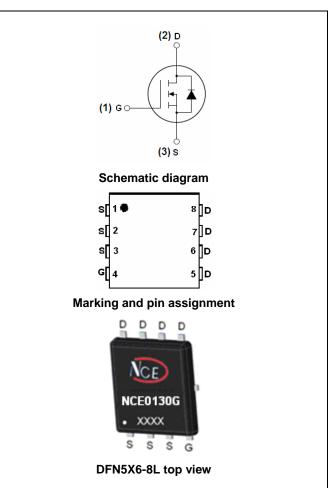
The NCE0130G uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- $V_{DS} = 100V, I_D = 30A$ $R_{DS(ON)} < 28m\Omega @ V_{GS} = 10V$ (Typ:24m Ω)
- Special process technology for high ESD capability
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE0130G	NCE0130G	DFN5X6-8L	-	-	-

Absolute Maximum Ratings (T_c=25℃ unless otherwise noted)

Symbol	Parameter	Limit	Unit
Vds	Drain-Source Voltage	100	V
Vgs	Gate-Source Voltage	±20	V
I _D	Drain Current-Continuous	30	А
I _D (100℃)	Drain Current-Continuous(TC=100°C)	21	A
I _{DM}	Pulsed Drain Current	70	A
PD	Maximum Power Dissipation	75	W
	Derating factor	0.5	W/°C
T_{J},T_{STG}	Operating Junction and Storage Temperature Range	-55 To 175	°C

Thermal Characteristic

R _{0JC} Thermal Resistance, Junction-to-Case ^(Note 2)	2.0	°C/W
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Electrical Characteristics (T_c=25 $^\circ\!\mathrm{C}$ unless otherwise noted)

bol	Parameter	Condition	Min	Тур	Max	Unit
Drain-Source Breakdown Voltage		V _{GS} =0V I _D =250µA	100	110	-	V
Zero Gate Voltage Drain Current		V _{DS} =100V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current		V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
ote 3)		·				
Gate Threshold Voltage		V _{DS} =V _{GS} ,I _D =250µA	2	3	4	V
Drain-Source On-St	ate Resistance	V _{GS} =10V, I _D =10A	-	24	28	mΩ
Forward Transconductance		V _{DS} =5V,I _D =10A	-	15	-	S
tics ^(Note4)		·				
Input Capac	citance		-	2000	-	PF
Output Capa	citance		-	300	-	PF
Reverse Transfer	Capacitance	F=1.0WHZ	-	250	-	PF
stics (Note 4)						
Turn-on Dela	ay Time		-	7	-	nS
Turn-on Ris	e Time	V_{DD} =50V,RL=5 Ω	-	7	-	nS
Turn-Off Dela	ay Time	V_{GS} =10V, R_{GEN} =3 Ω	-	29	-	nS
Turn-Off Fa	ll Time		-	7	-	nS
Total Gate (Charge)/ _===0)// ====0.0	-	39	-	nC
Gate-Source	Charge		-	8	-	nC
Gate-Drain	Charge	V _{GS} =10V	-	12	-	nC
Characteristics		·				
Diode Forward V	oltage (Note 3)	V _{GS} =0V,I _S =20A	-	-	1.2	V
		-	-	-	30	А
Reverse Recov	very Time	TJ = 25°C, IF = 18A	-	32	-	nS
Reverse Recove	ery Charge	di/dt = 100A/µs ^(Note3)	-	53	-	nC
Forward Turn-	On Time	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD				v LS+LD)
	Drain-Source Break Zero Gate Voltage Gate-Body Leaka ote 3) Gate Threshold Drain-Source On-St Forward Transco tics (Note 4) Input Capad Output Capad Reverse Transfer Stics (Note 4) Turn-on Dela Turn-on Ris Turn-Off Dela Turn-Off Dela Turn-Off Fa Total Gate C Gate-Source Gate-Drain (Characteristics Diode Forward V Diode Forward C Reverse Recove	Drain-Source Breakdown Voltage Zero Gate Voltage Drain Current Gate-Body Leakage Current ote 3) Gate Threshold Voltage Drain-Source On-State Resistance Forward Transconductance tics (Note4) Input Capacitance Output Capacitance Reverse Transfer Capacitance istics (Note 4) Turn-on Delay Time Turn-on Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge	$\begin{tabular}{ c c c c c } \hline $V_{GS}=0V\ I_D=250\muA$ \\ \hline $Zero\ Gate\ Voltage\ Drain\ Current$ & $V_{DS}=100V,V_{GS}=0V$ \\ \hline $Gate-Body\ Leakage\ Current$ & $V_{GS}=\pm20V,V_{DS}=0V$ \\ \hline $Gate-Body\ Leakage\ Current$ & $V_{GS}=\pm20V,V_{DS}=0V$ \\ \hline $Gate-Body\ Leakage\ Current$ & $V_{GS}=\pm20V,V_{DS}=0V$ \\ \hline $Gate-Body\ Leakage\ Current$ & $V_{GS}=10V,\ I_D=10A$ \\ \hline $Drain-Source\ On-State\ Resistance$ & $V_{GS}=10V,\ I_D=10A$ \\ \hline $Forward\ Transconductance$ & $V_{DS}=5V,I_D=10A$ \\ \hline $Forward\ Transconductance$ & $V_{DS}=5V,I_D=10A$ \\ \hline $tics\ (Note4)$ \\ \hline $Input\ Capacitance$ & $V_{DS}=25V,V_{GS}=0V$, $F=1.0MHz$ \\ \hline $Forward\ Transfer\ Capacitance$ & $V_{DS}=25V,V_{GS}=0V$, $F=1.0MHz$ \\ \hline $Forward\ Turn-on\ Delay\ Time$ & $V_{DD}=50V,R_L=5\Omega$ \\ \hline $V_{GS}=10V,R_{GEN}=3\Omega$ \\ \hline $Turn-Off\ Delay\ Time$ & $V_{DS}=50V,I_D=18A$, $V_{GS}=10V$ \\ \hline $Gate-Drain\ Charge$ & $V_{GS}=0V,I_S=20A$ \\ \hline $Diode\ Forward\ Voltage\ (Note\ 3)$ & $V_{GS}=0V,I_S=20A$ \\ \hline $Diode\ Forward\ Voltage\ (Note\ 3)$ & $V_{GS}=0V,I_S=20A$ \\ \hline $Diode\ Forward\ Current\ (Note\ 2)$ & $-$ \\ \hline $Reverse\ Recovery\ Time$ & $TJ=25^\circC$, IF=\ 18A$ \\ $di/dt=\ 100A/\mus\ (Note\ 3)$ & $di/dt=\ 100A/\mus\ (Note\ 3)$ \\ \hline $di/dt=\ 100A/\mus\ (Note\ 3)$ & $di/dt=\ 100A/\mus\ (Note\ 3)$ \\ \hline $di/dt=\ 100A/\mus\ (Note\ 3)$ & $di/dt=\ 100A/\mus\ (Note\ 3)$ \\ \hline $di/dt=\ 100A/\mus\ (Note\ 3)$ & $di/dt=\ 100A/\mus\ (Note\ 3)$ \\ \hline $di/dt=\ 100A/\mus\ (Note\ 3)$ & $di/dt=\ 100A/\mus\ (Note\ 3)$ \\ \hline $di/dt=\ 100A/\mus\ (Note\ 3)$ & $di/dt=\ 100A/\mus\ (Note\ 3)$ \\ \hline $di/dt=\ 100A/\mus\ (Note\ 3)$ & $di/dt=\ 100A/\mus\ (Note\ 3)$ \\ \hline $di/dt=\ 100A/\mus\ (Note\ 3)$ & $di/dt=\ 100A/\mus\ (Note\ 3)$ \\ \hline $di/dt=\ 100A/\mus\ (Note\ 3)$ & $di/dt=\ 100A/\mus\ (Note\ 3)$ \\ \hline $di/dt=\ 100A/\mus\ (Note\ 3)$ & $di/dt=\ 100A/\mus\ (Note\ 3)$ \\ \hline $di/dt=\ 100A/\mus\ (Note\ 3)$ & $di/dt=\ 100A/\mus\ (Note\ 3)$ \\ \hline $di/dt=\ 100A/\mus\ (Note\ 3)$ & $di/dt=\ 100A/\mus\ (Note\ 3)$ \\ \hline $di/dt=\ 100A/\mus\ (Note\ 3)$ & $di/dt=\ 100A/\mus\ (Note\ 3)$ \\ \hline $di/dt=\ 100A/\mus\ (Note\ 3)$ & $di/dt=\ 10A/\mus\ (Note\ 3)$ \\ \hline $di/dt=\ 10A/\mus\ (Note\ 3)$ & $$	$\begin{tabular}{ c c c c } \hline $V_{GS}=0V \ I_D=250\muA$ & 100 \\ \hline $Zero Gate Voltage Drain Current$ & $V_{DS}=100V, $V_{GS}=0V$ & -$$$$$$$$$$$$$$$$$$$$$$$$$$$$$$$$$$$	$\begin{tabular}{ c c c c c } \hline Prain-Source Breakdown Voltage $V_{GS}=0V \ I_D=250\muA$ 100 110 $$$$$$$$$$$$$$$$$$$$$$$$$$$$$$	$ \begin{array}{ c c c c c c } \hline Prain-Source Breakdown Voltage $V_{GS}=0V \ l_{D}=250 \mu A$ 100 110 $-$ 100 $V_{GS}=0V$ $-$ $-$ $100 $V_{DS}=100V, V_{GS}=0V$ $-$ $-$ $100 $V_{GS}=20V$ $V_{DS}=20V, V_{DS}=0V$ $-$ $-$ $100 $V_{CS}=220V, V_{DS}=0V$ $-$ $-$ $100 $V_{CS}=220V, V_{DS}=20V$ $-$ $-$ $100 $V_{CS}=250 \mu A$ $-$ 2 3 4 $Drain-Source On-State Resistance $V_{GS}=10V, \ l_{D}=10A$ $-$ 24 28 $Forward Transconductance $V_{DS}=5V, \ l_{D}=10A$ $-$ 24 28 $V_{CS}=10V$ $I_{D}=10A$ $-$ 15 $-$ $V_{CS}=10V$ $I_{D}=10A$ $-$ 15 $-$ $V_{CS}=10V$ $V_{CS}=25V, \ V_{GS}=0V$ $V_{CS}=0V$ $V_{CS}=10V$ $V_{CS}=0V$ $V_{CS}=10V$ $V_{CS}=0V$ V_{C

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, t ≤ 10 sec.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

4. Guaranteed by design, not subject to production

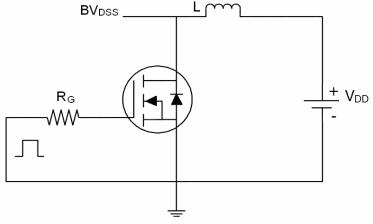


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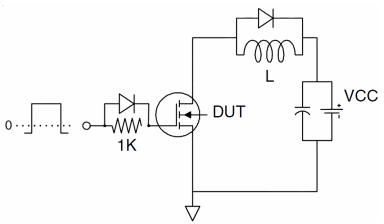




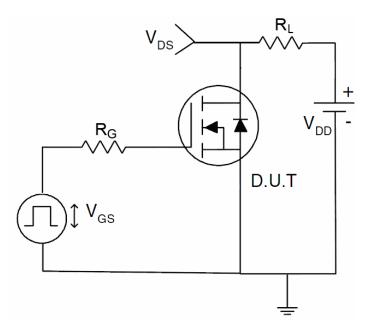
Test Circuit 1) E_{AS} Test Circuit



2) Gate Charge Test Circuit



3) Switch Time Test Circuit

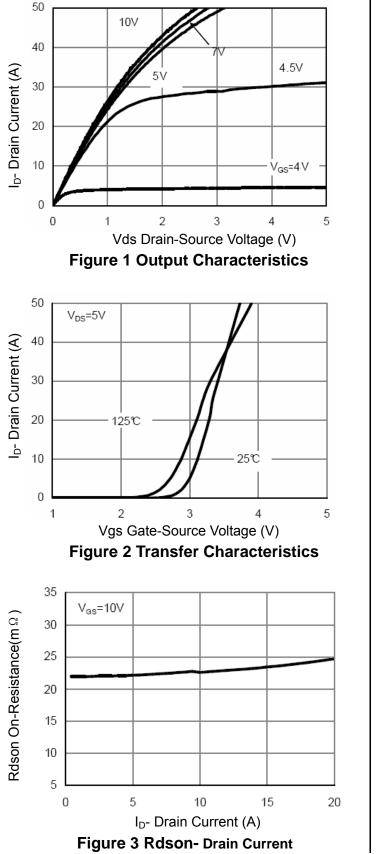


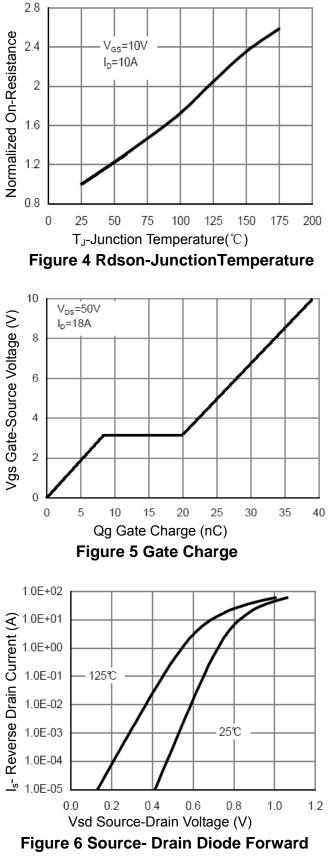






Typical Electrical and Thermal Characteristics (Curves)



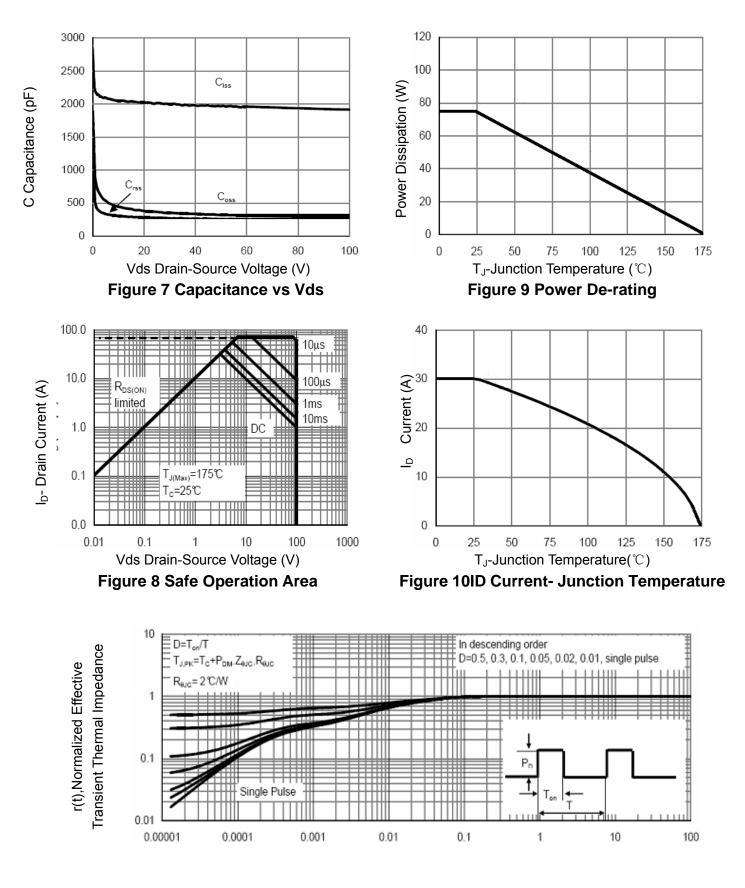




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Square Wave Pluse Duration(sec) Figure 11 Normalized Maximum Transient Thermal Impedance

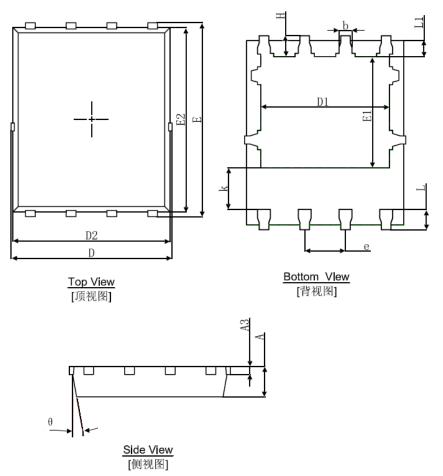


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NCE0130G

DFN5X6-8L Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	0.900	1.000	0.035	0.039	
A3	0.25	0.254REF.		REF.	
D	4.944	5.096	0.195	0.201	
E	5.974	6.126	0.235	0.241	
D1	3.910	4.110	0.154	0.162	
E1	3.375	3.575	0.133	0.141	
D2	4.824	4.976	0.190	0.196	
E2	5.674	5.826	0.223	0.229	
К	1.190	1.390	0.047	0.055	
b	0.035	0.450	0.014	0.018	
e	1.270)(TYP.)	0.050(TYP.)		
L	0.559	0.711	0.022	0.028	
L1	0.424	0.576	0.017	0.023	
Н	0.574	0.726	0.023	0.029	
θ	8°	12°	8°	12°	







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